



DOCUMENT CHANGE REQUEST

DCR number	1370	Changes required for:	General	Originator:	FRANCOIS VACHER
Date:	2021/02/18	Date sent:	2020/01/02	Organisation:	CNES
Status:	IMPLEMENTED				

Title: Integrated Circuits: Monolithic And Multichip Microcircuits, Wire-Bonded, Hermetically Sealed And

Number: 9000 Issue: 10

Other documents affected:

Page:

Paragraph:

Original wording:

The original DCR attachment shall be replaced by the following that highlights all changes per DCR1370 (and also DCR1369):
ESCC9000 Draft 11C+ per DCR1370 &1369.docx

Proposed wording:

Justification:

The original DCR attachment shall be replaced by the following that highlights all changes per DCR1370 (and also DCR1369):
ESCC9000 Draft 11C+ per DCR1370 &1369.docx



DOCUMENT CHANGE REQUEST

DCR number	1370	Changes required for:	General	Originator:	FRANCOIS VACHER
Date:	2021/02/18	Date sent:	2020/01/02	Organisation:	CNES
Status:	IMPLEMENTED				

Title: Integrated Circuits: Monolithic And Multichip Microcircuits,Wire-Bonded, Hermetically Sealed And

Number: 9000 Issue: 10

Other documents affected:

Page:

30, 31, 34, 42, 43, 46, 48

Paragraph:

8.4 (b) and (e), 12.3.1 Chart F2A, 12.3.2Chart F2B, 12.5.1 Chart F4A - Note 17, 12.5.2 chart F4B, 8.11.1, 8.20, 8.19

Original wording:

See attached document

Proposed wording:

See attached document

Justification:

See attached document

Attachments:

esc9000_draft_11d_per_dcr1370_&1369.docx

Modifications:

The original DCR attachment shall be replaced by the following that highlights all changes per DCR1370 (and also DCR1369):

ESCC9000 Draft 11C+ per DCR1370 &1369.docx

Approval signature:

Date signed:

2021-02-18

